## Multilayer Ceramic Chip Capacitors

## C4532X7R1H335K200KA



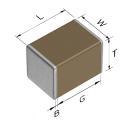






#### **TDK item description** C4532X7R1H335KT\*\*\*\*

Applications	Commercial Grade  Please refer to Part No. CGA8M2X7R1H335K200KA for Automotive use.		
Feature	General General (Up to 75V)		
Series	C4532 [EIA 1812]		
Status	Production		



	Size
Length(L)	4.50mm ±0.40mm
Width(W)	3.20mm ±0.40mm
Thickness(T)	2.00mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	3.10mm to 3.70mm
Recommended Land Pattern (PB)	1.20mm to 1.40mm
Recommended Land Pattern (PC)	2.40mm to 3.20mm

Electrical Characteristics		
Capacitance	3.3µF ±10%	
Rated Voltage	50VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	151ΜΩ	

Other		
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	1000pcs	

<sup>!</sup> Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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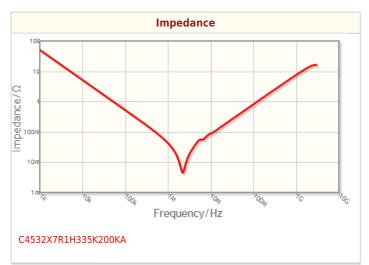


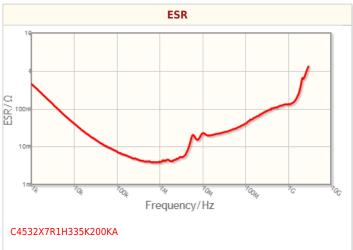


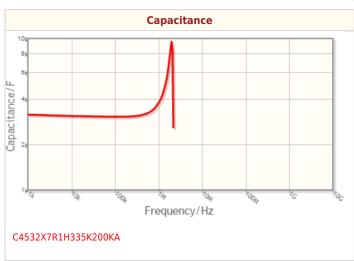


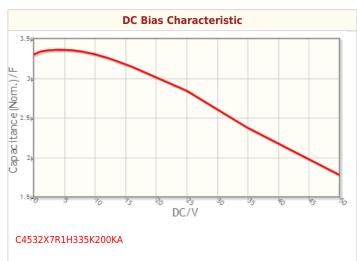


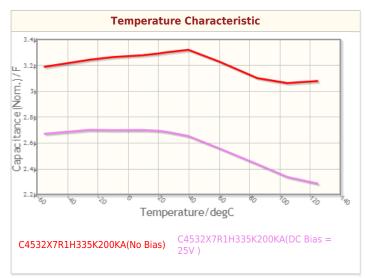
# Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

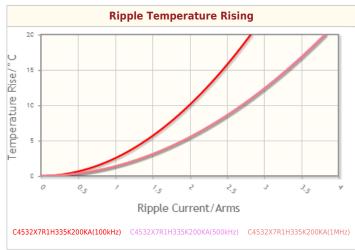












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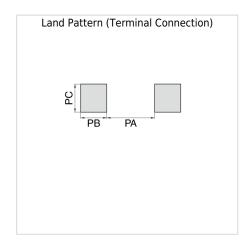








# **Associated Images**



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